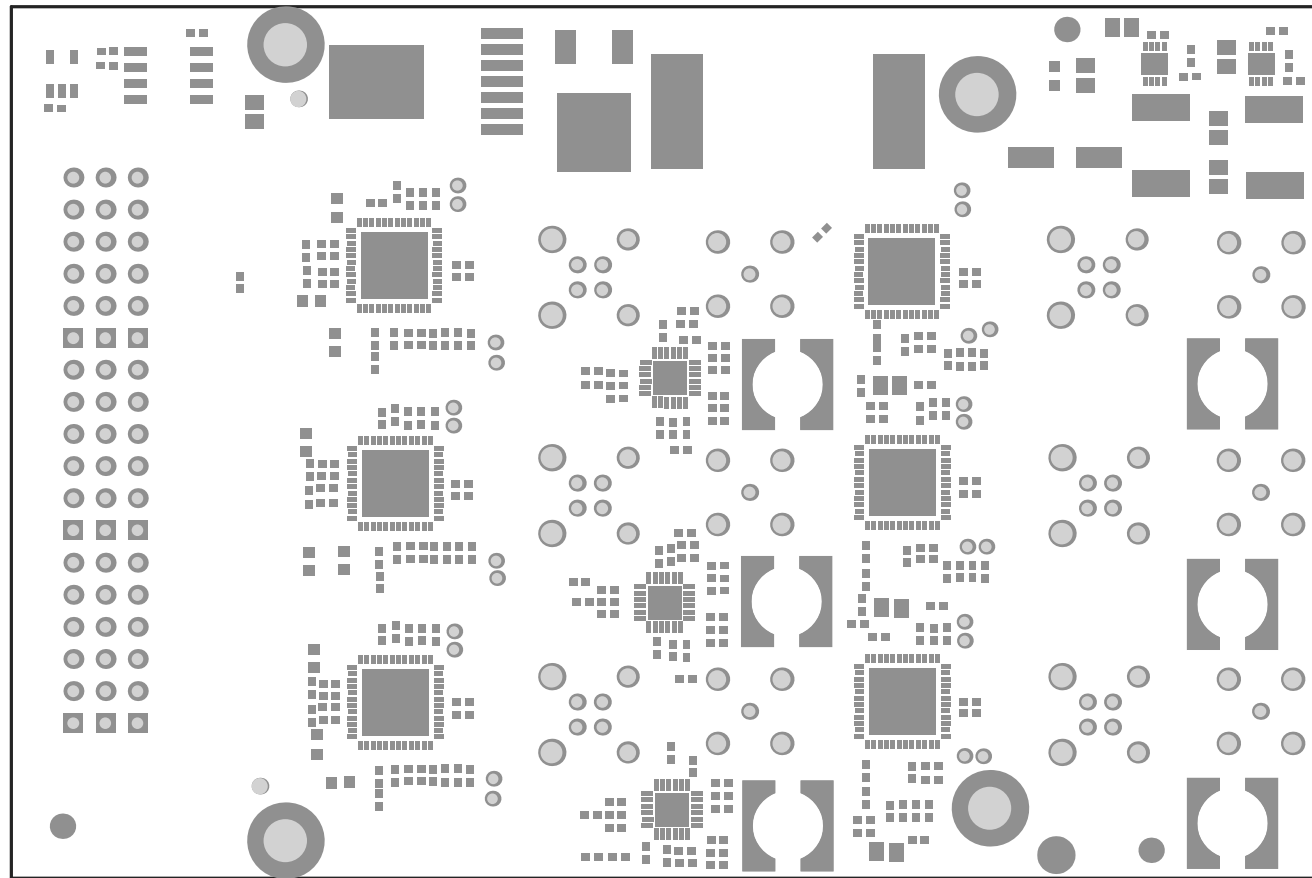
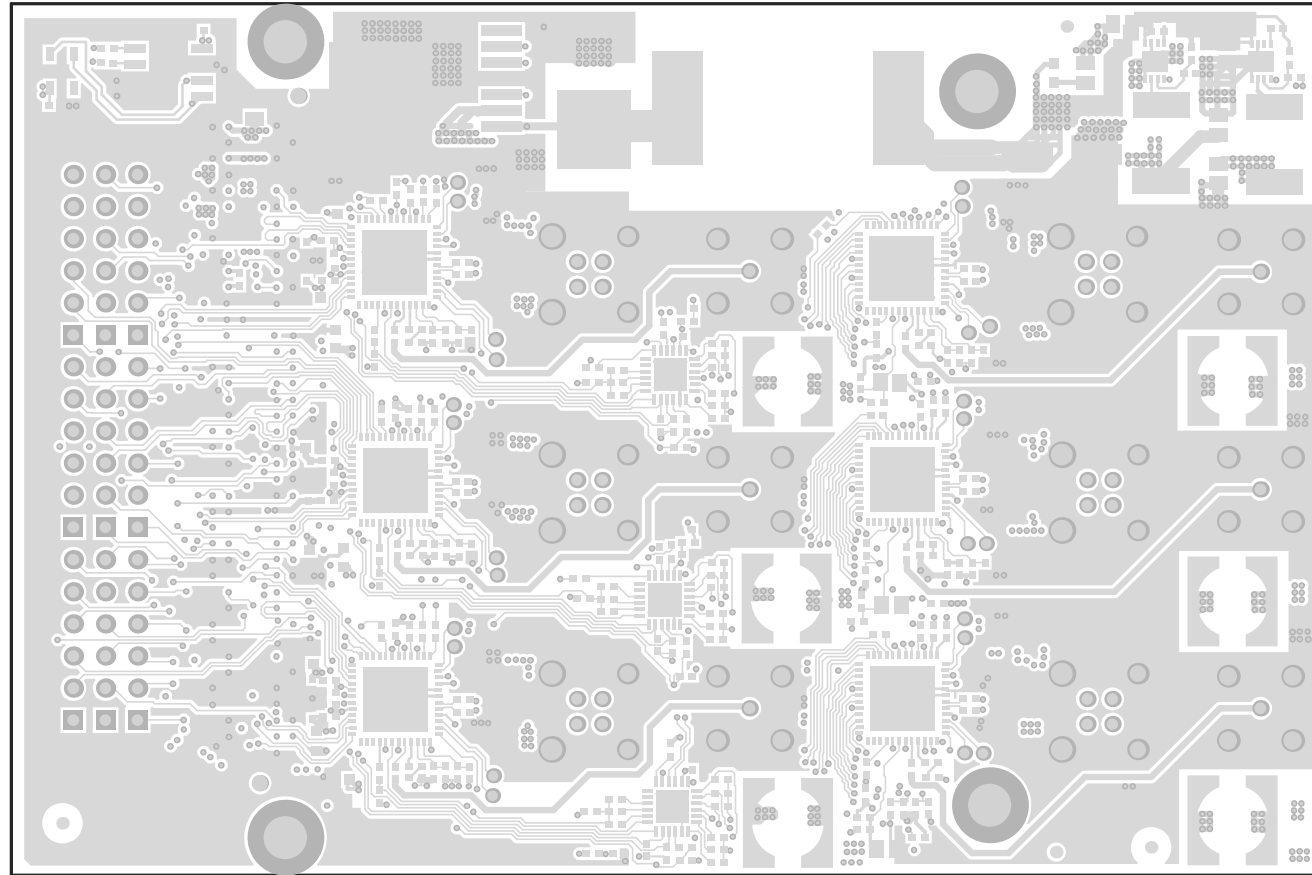


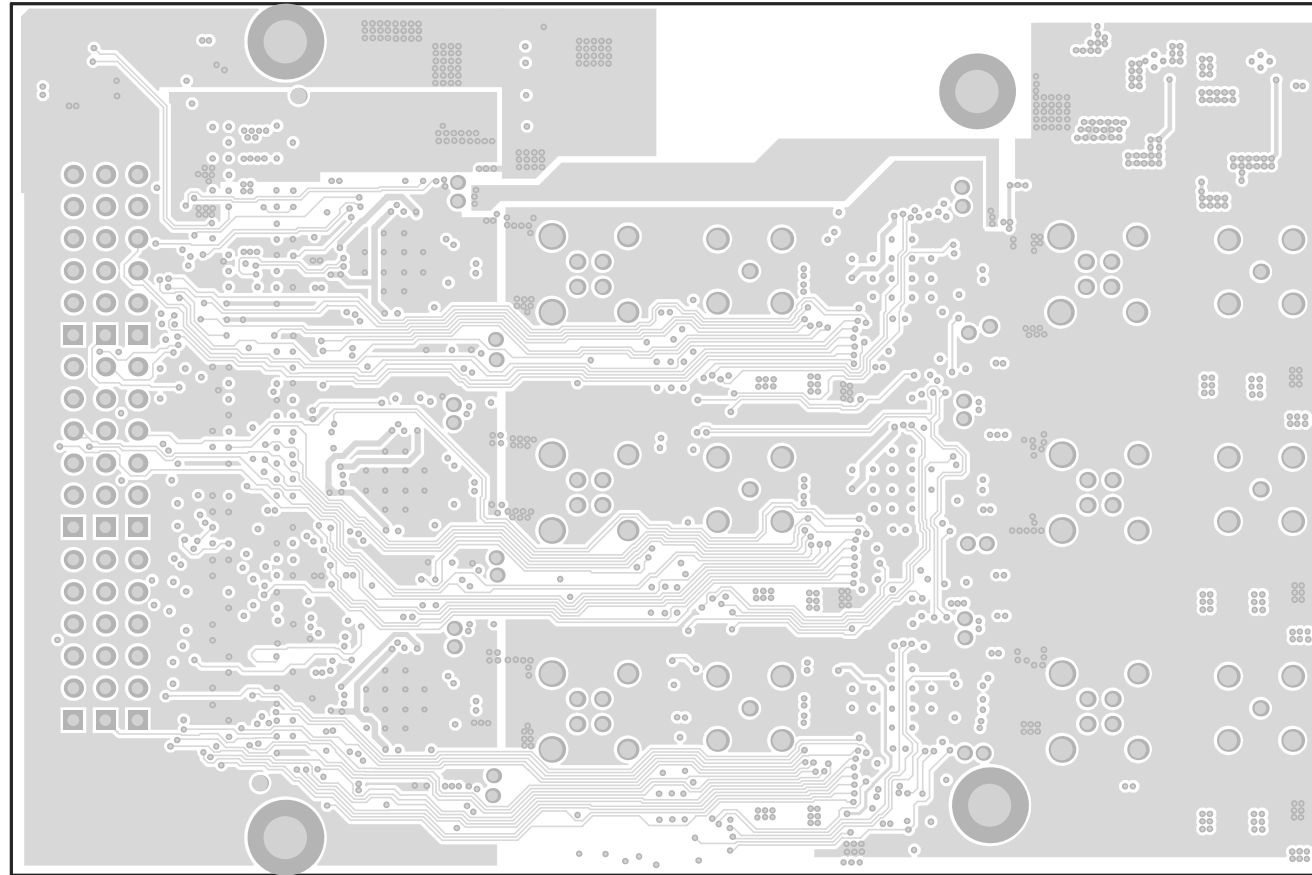
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: SAT0089	REV: E2	SUN REV: Not In VersionControl
LAYER NAME = Top Overlay			
PLOT NAME = Top Overlay	GENERATED : 4/10/2014 1:13:55 PM	TEXAS INSTRUMENTS	



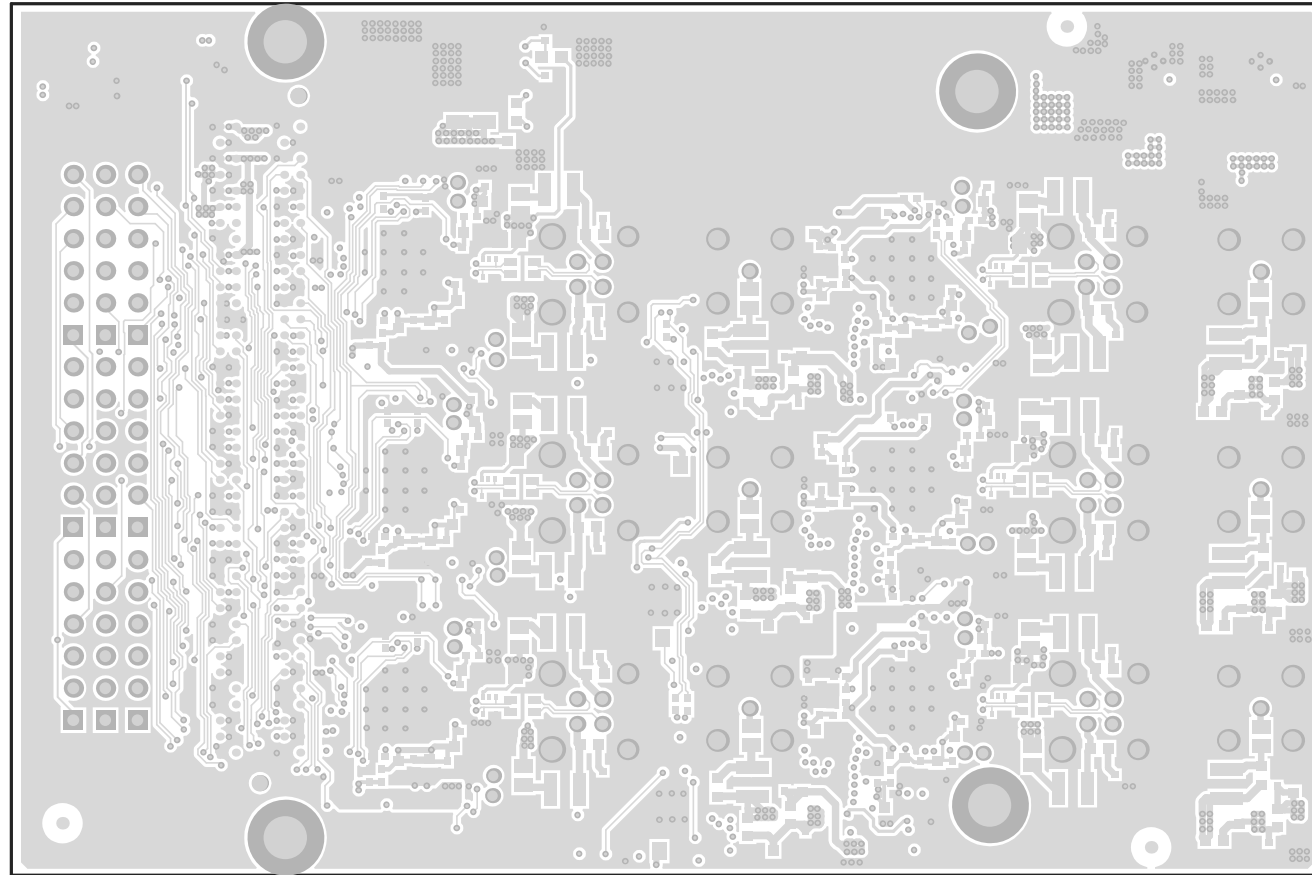
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: SAT0089	REV: E2	SUN REV: Not In VersionControl
LAYER NAME = Top Solder			
PLOT NAME = Top Solder Mask	GENERATED : 4/10/2014 1:13:55 PM	TEXAS INSTRUMENTS	



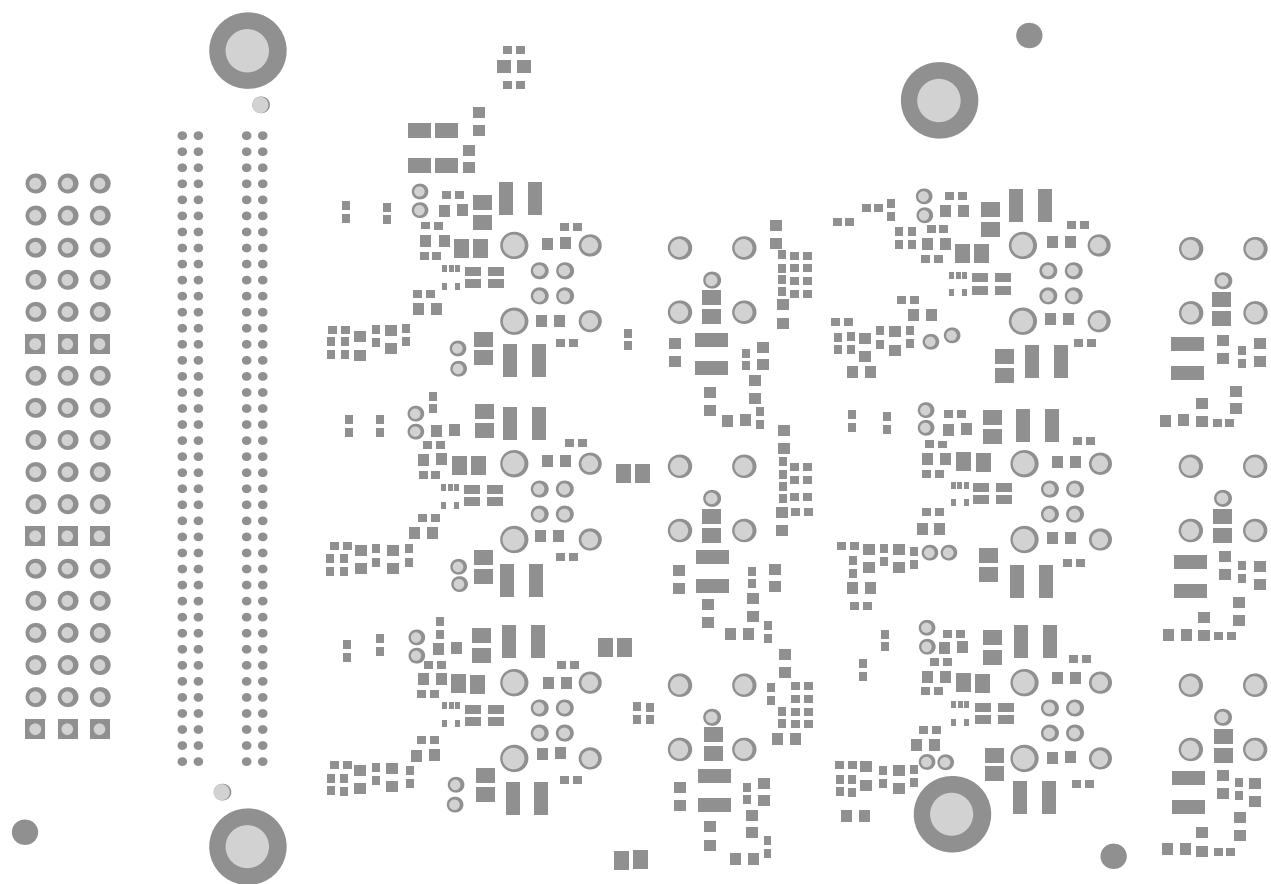
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LAYER NAME = Top Layer			
PLOT NAME = Top Layer	GENERATED : 4/10/2014 1:13:56 PM	TEXAS INSTRUMENTS	



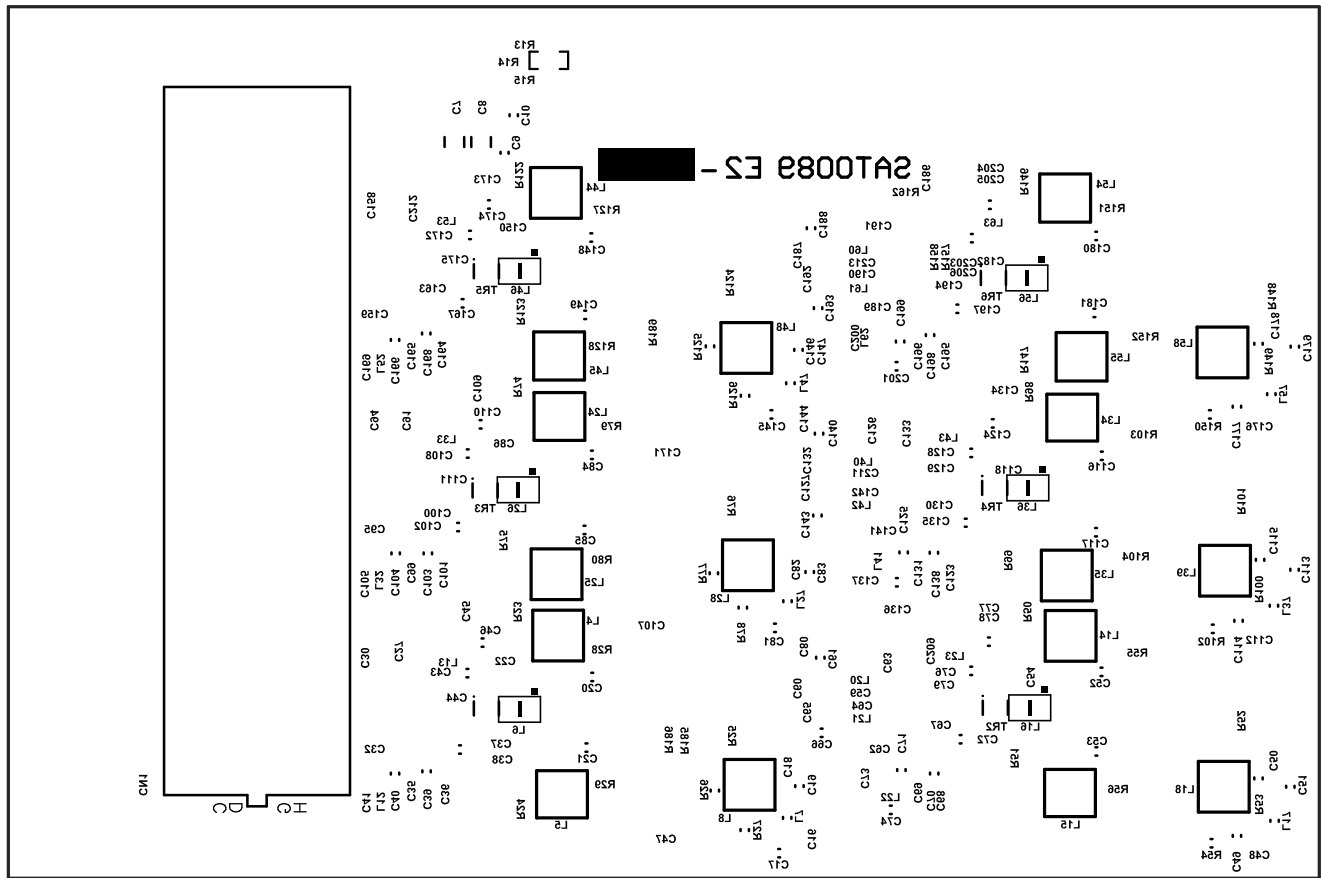
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: SAT0089	REV: E2	SUN REV: Not In VersionControl
LAYER NAME = MidLayer1			
PLOT NAME = MidLayer1	GENERATED : 4/10/2014 1:13:57 PM	TEXAS INSTRUMENTS	



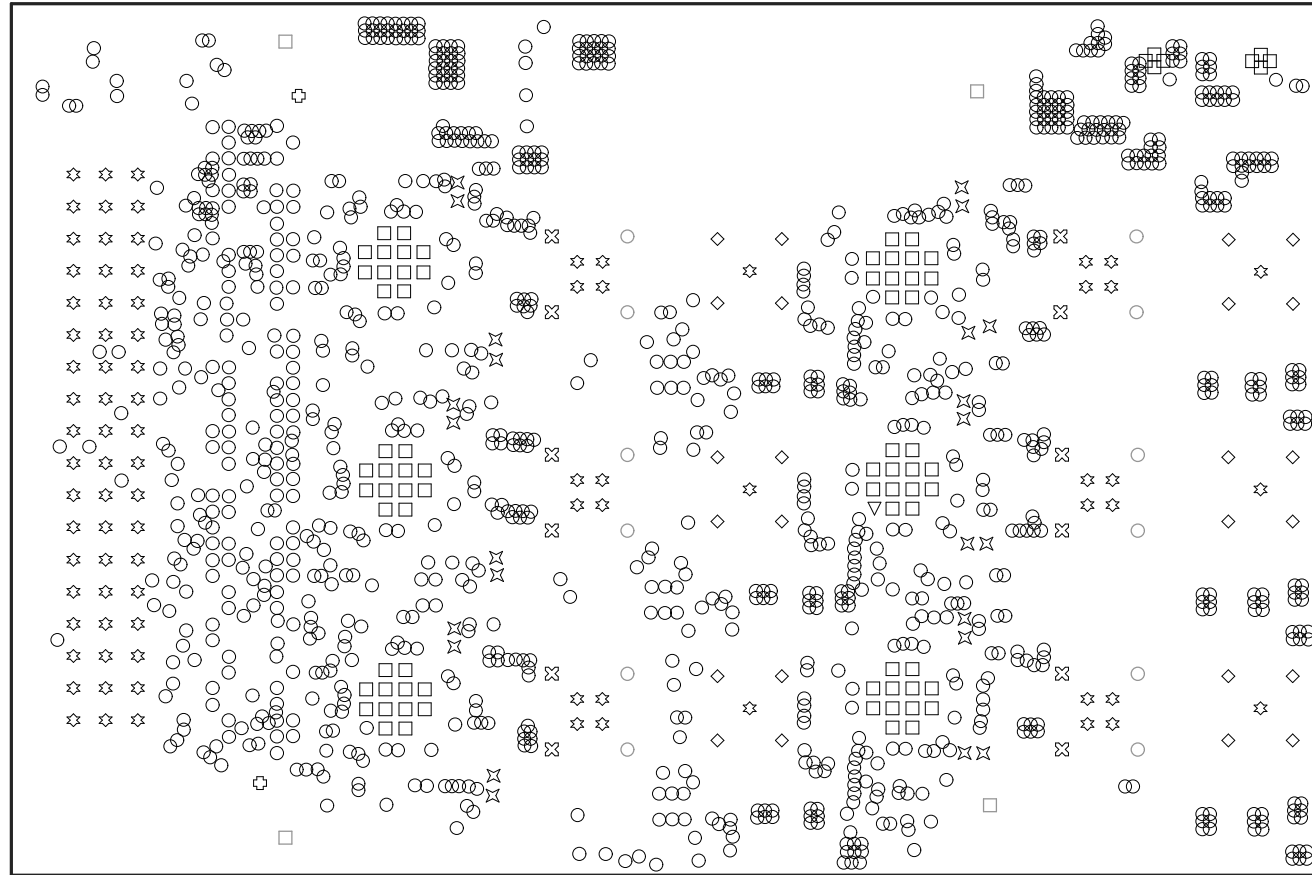
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: SAT0089	REV: E2	SUN REV: Not In VersionControl
LAYER NAME = Bottom Layer			
PLOT NAME = Bottom Layer	GENERATED : 4/10/2014 1:13:58 PM	TEXAS INSTRUMENTS	



ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: SAT0089	REV: E2	SUN REV: Not In VersionControl
LAYER NAME = Bottom Solder			
PLOT NAME = Bottom Solder Mask	GENERATED : 4/10/2014 1:13:58 PM	TEXAS INSTRUMENTS	



ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: SAT0089	REV: E2	SUN REV: Not In VersionControl
LAYER NAME = Bottom Overlay			
PLOT NAME = Bottom Overlay	GENERATED : 4/10/2014 1:13:59 PM	TEXAS INSTRUMENTS	



Symbol	Hit Count	Tool Size	Plated	Hole Type
□	80	7.874mil (0.2mm)	PTH	Round
○	1155	9.842mil (0.25mm)	PTH	Round
▽	1	10mil (0.254mm)	PTH	Round
✕	24	32mil (0.813mm)	PTH	Round
☆	84	35.433mil (0.9mm)	PTH	Round
⊕	2	50mil (1.27mm)	NPTH	Round
○	12	51.181mil (1.3mm)	PTH	Round
◇	24	55.118mil (1.4mm)	PTH	Round
⊗	12	66.929mil (1.7mm)	PTH	Round
□	4	133.858mil (3.4mm)	PTH	Round
1398 Total				

Drill Table

ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: SAT0089	REV: E2	SUN REV: Not In VersionControl
LAYER NAME = Drill Drawing			
PLOT NAME = Drill Drawing	GENERATED : 4/10/2014 1:14:00 PM	TEXAS INSTRUMENTS	



ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: SAT0089	REV: E2	SUN REV: Not In VersionControl
LAYER NAME = M2 Board Dimensions			
PLOT NAME = Board Dimensions	GENERATED : 4/10/2014 1:14:00 PM	TEXAS INSTRUMENTS	

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